

Substitute for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use as many sheets as necessary)		Complete if Known	
		Application Number	
		09/838493	
		Filing Date	April 19, 2001
		First Named Inventor	Chopra, Dinesh
		Group Art Unit	2811 2823
Examiner Name	Unknown Khiem D. Nguyen		
Sheet 1 of 1			
Attorney Docket No: 00303.658US1			

US PATENT DOCUMENTS						
Examiner Initials*	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Class	Subclass	Filing Date If Appropriate
K.N.	US-5151168	09/29/1992	Gilton, et al	205	123	09/24/1990
K.N.	US-5877069	03/02/1999	Robinson, Karl M.	438	441	09/16/1996
K.N.	US-5893966	04/13/1999	Akram, Salman, et al	205	137	07/24/1997
K.N.	US-5933758	08/03/1999	Jain, A.	438	687	05/12/1997
K.N.	US-6077412	06/20/2000	Ting, Chiu H., et al	205	143	10/30/1998

FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited Document	Class	Subclass	T ²

OTHER DOCUMENTS -- NON PATENT LITERATURE DOCUMENTS						
Examiner Initials*	Cite No ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.				T ²
K.N.		BRAUN, ALEXANDER.E. , "Aluminum Persists as Copper Age Dawns", Semiconductor International vol. 22, no. 9, (August 1999), 58-60, 63, 64, 66				
K.N.		BRAUN, ALEXANDER.E. , "Copper Electroplating Enters Mainstream Processing", Semiconductor International, vol. 22, no. 4, (04/1999), 58-60, 62, 64, 66				
K.N.		DORSCH, JEFF, "Applied Does Quick Turnaround on CU Process", Electronic News(1991), (11/08/1999), 36				

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